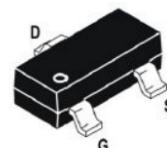
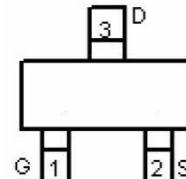
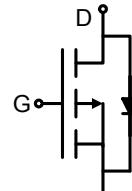


## FEATURES

- |           |                             |                             |       |
|-----------|-----------------------------|-----------------------------|-------|
| $V_{DSS}$ | $R_{DS(ON)}$<br>@-4.5V(Typ) | $R_{DS(ON)}$<br>@-2.5V(Typ) | $I_D$ |
| -20V      | 65mΩ                        | 83mΩ                        | -3A   |

- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package



SOT-23

## Application

- PWM applications
- Load switch
- Power management

## Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 10$	V
Drain Current-Continuous	$I_D$	-3	A
Drain Current -Pulsed (Note 1)	$I_{DM}$	-10	A
Maximum Power Dissipation	$P_D$	1	W
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 150	°C

## Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	125	°C/W
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## Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise noted)

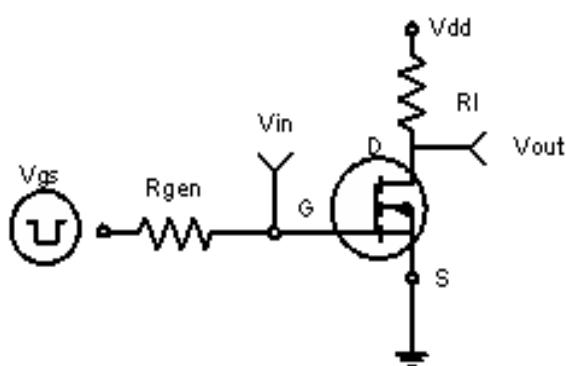
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V I_D=-250\mu\text{A}$	-20		-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-20V, V_{GS}=0V$	-	-	-1	$\mu\text{A}$

Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =0V	-	-	-100	nA
<b>On Characteristics (Note 3)</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.4	-0.65	-1	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3A	-	65	85	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2A	-	83	120	mΩ
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-2.8A	-	9.5	-	S
<b>Dynamic Characteristics (Note4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V, F=1.0MHz	-	405	-	PF
Output Capacitance	C <sub>oss</sub>		-	75	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	55	-	PF
<b>Switching Characteristics (Note 4)</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-10V, I <sub>D</sub> =-1A V <sub>GS</sub> =-4.5V, R <sub>GEN</sub> =10Ω	-	11	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	35	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-3A, V <sub>GS</sub> =-2.5V	-	3.3	12	nC
Gate-Source Charge	Q <sub>gs</sub>		-	0.7	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	1.3	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =1.3A	-	-	-1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	-1.3	A

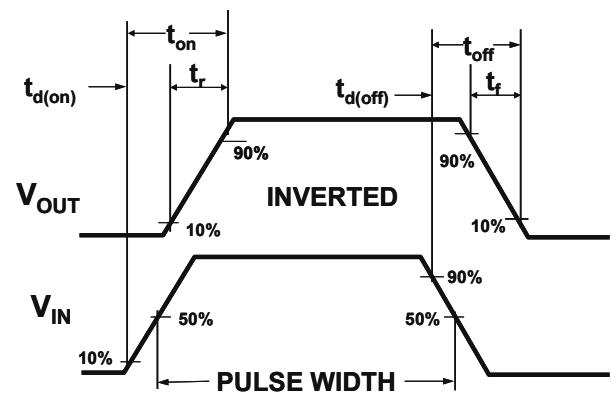
### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

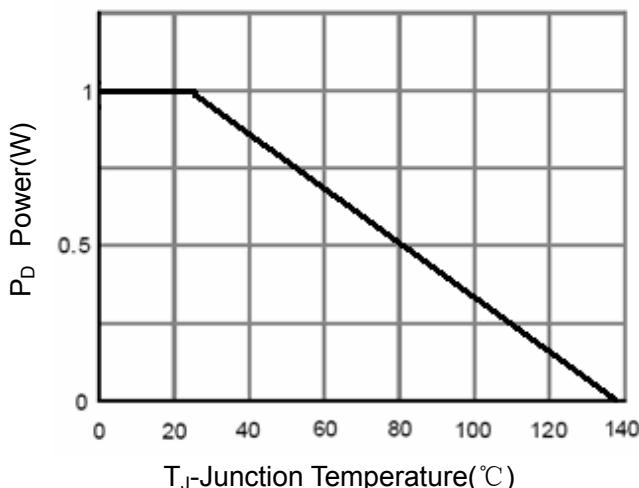
## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



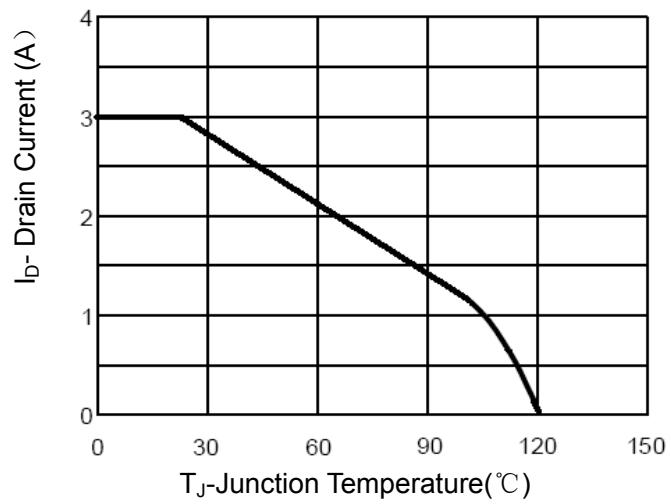
**Figure 1:Switching Test Circuit**



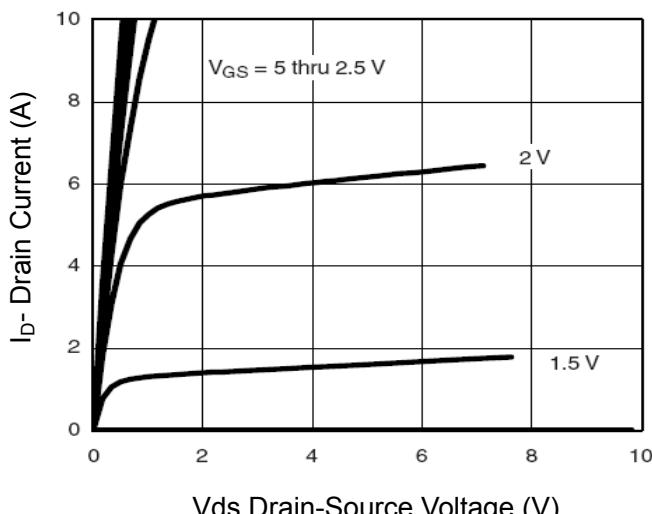
**Figure 2:Switching Waveforms**



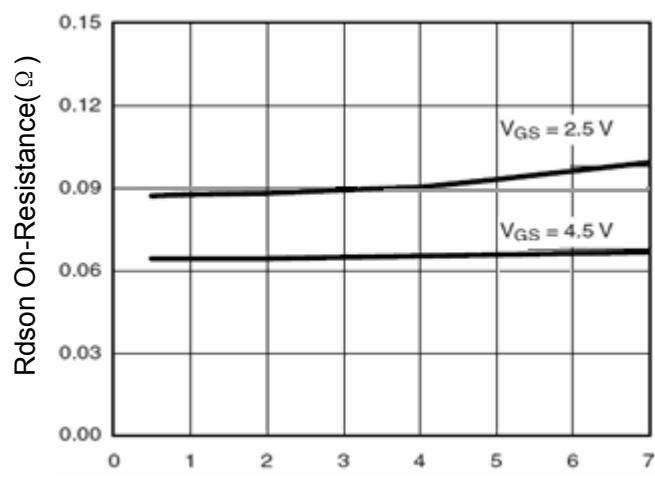
**Figure 3 Power Dissipation**



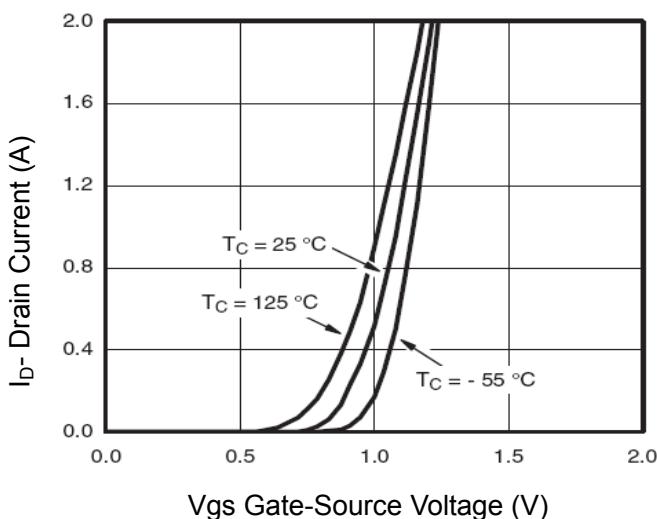
**Figure 4 Drain Current**



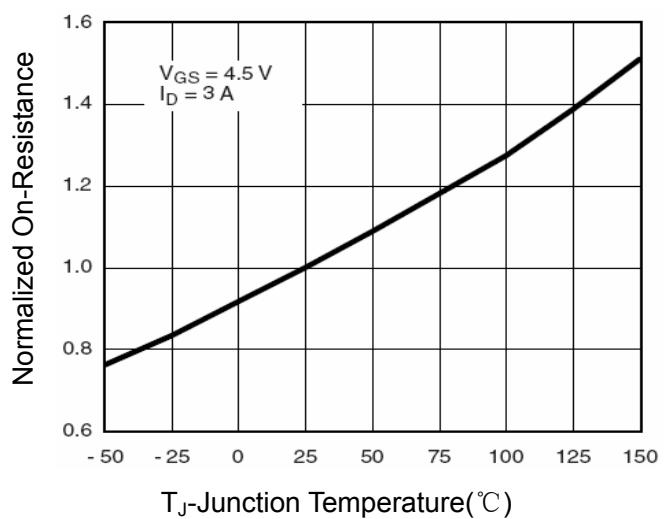
**Figure 5 Output CHARACTERISTICS**



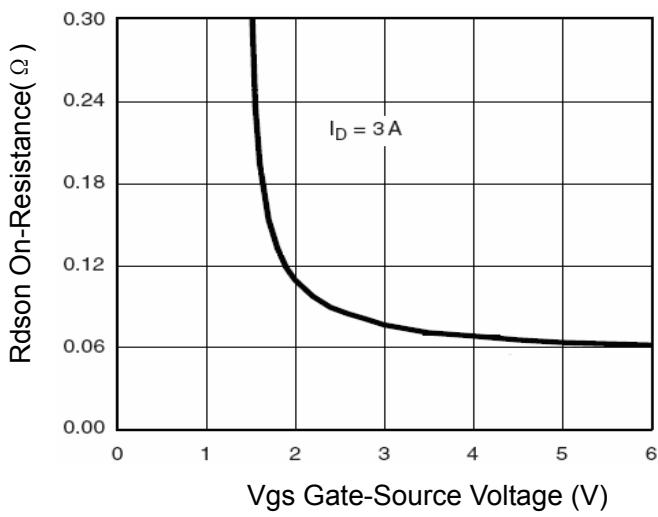
**Figure 6 Drain-Source On-Resistance**



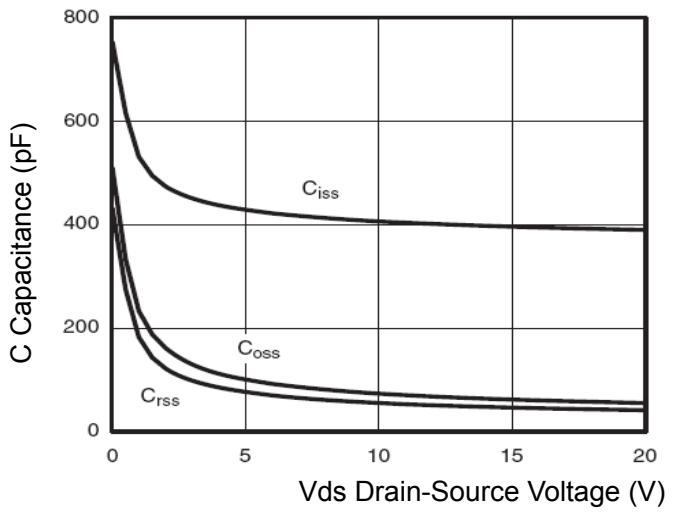
**Figure 7 Transfer Characteristics**



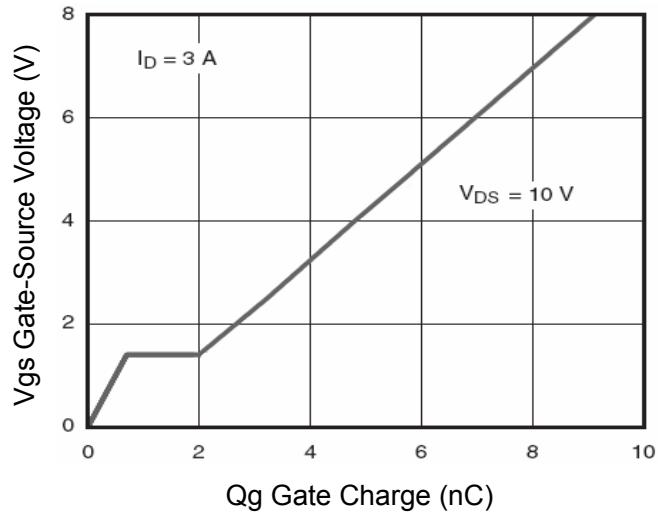
**Figure 8 Drain-Source On-Resistance**



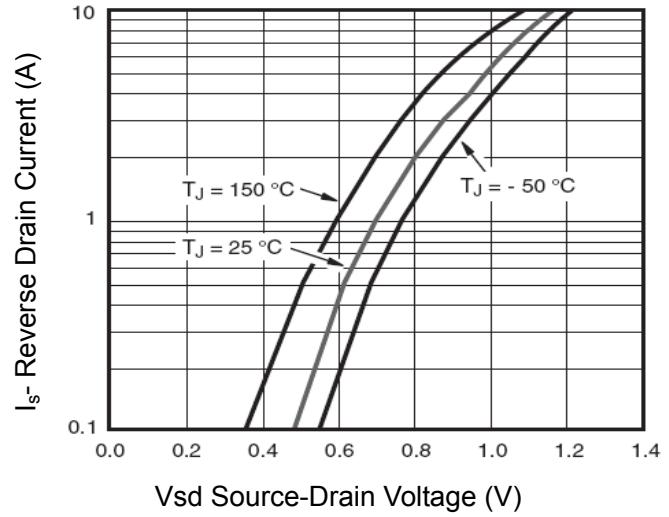
**Figure 9  $R_{DS(on)}$  vs  $V_{GS}$**



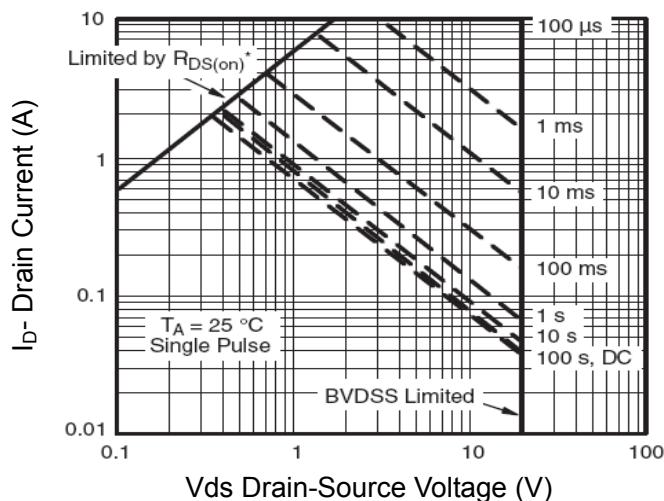
**Figure 10 Capacitance vs  $V_{DS}$**



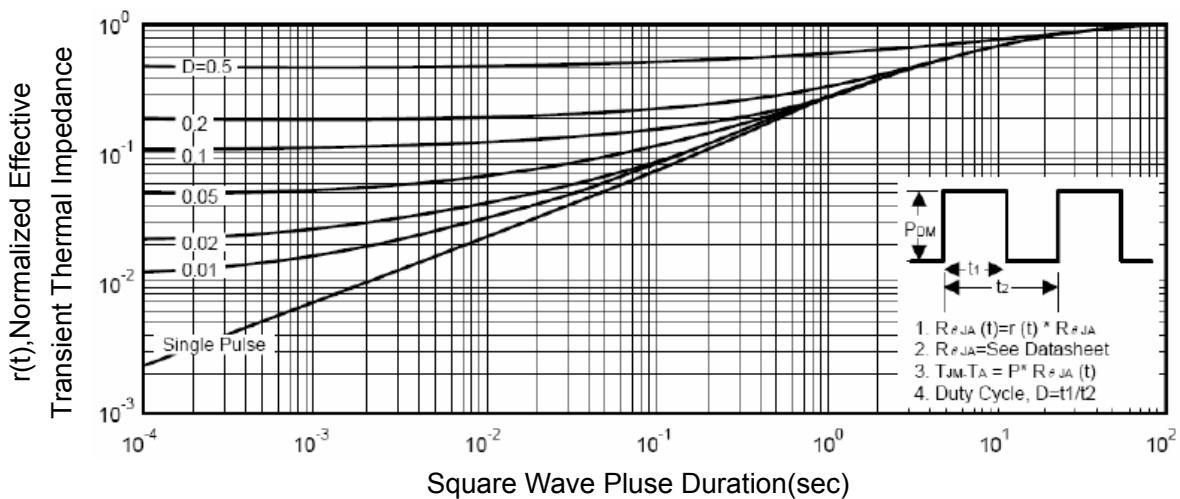
**Figure 11 Gate Charge**



**Figure 12 Source- Drain Diode Forward**



**Figure 13 Safe Operation Area**



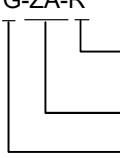
**Figure 14 Normalized Maximum Transient Thermal Impedance**

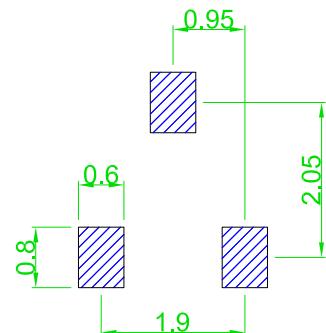
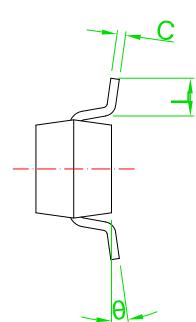
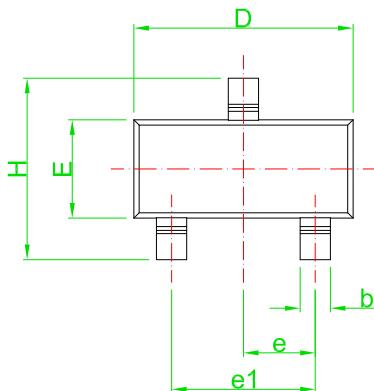
## Ordering and Marking Information

Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
ASDM2301ZA	A1SHB	SOT23	Tape&Reel	3000/Reel	-	-

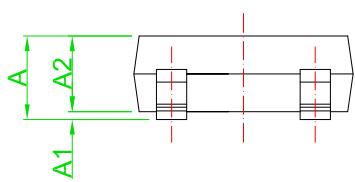
PACKAGE	MARKING
SOT23	A1SHB

Ordering Number		Package
Lead Free	Halogen Free	Package
ASDM2301-ZA-R	ASDM2301G-ZA-G-R	SOT23

ASDM2301G-ZA-R 	1 T:Tube,R:Tape Reel 2 ZA: SOT23 3 blank : Lead Free G:Halogen Free and Lead Free
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Recommended Land Pattern



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.90	1.15	0.035	0.045
A1	0.00	0.10	0.000	0.004
A2	0.90	1.05	0.035	0.041
b	0.30	0.55	0.012	0.022
C	0.08	0.15	0.003	0.006
D	2.80	3.00	0.110	0.118
E	1.20	1.40	0.047	0.055
e	0.95 TYP		0.037 TYP	
e1	1.80	2.00	0.071	0.079
H	2.25	2.55	0.089	0.100
L	0.30	0.50	0.012	0.020
θ	0°	8°	0°	8°

